

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung
Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.: 10/720,579 ART UNIT: 1753

FILED: November 24, 2003 EXAMINER: Wong, E.

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER
FOIL MANUFACTURED THEREBY

AMENDMENT "A"

Director of the U.S. Patent
and Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action of August 21, 2007, having a response with a one-month
Extension of Time due by December 21, 2007, please enter the amendments provided herein and
consider the following remarks.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung
Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.: 10/720,579 ART UNIT: 1753

FILED: November 24, 2003 EXAMINER: Wong, E.

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER FOIL
MANUFACTURED THEREBY

CERTIFICATE OF MAILING UNDER 37 CFR 1.8(a)

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Sir:

I hereby certify that the attached correspondence comprising:

AMENDMENT "A"

is being deposited with the United States Postal Service with sufficient postage as first class mail
in an envelope addressed to:

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

or by electronic filing on December 10, 2007.

Respectfully submitted,

<u>December 10, 2007</u>	<u>/Andrew W. Chu/</u>
Date	John S. Egbert: Reg. No. 30,627 Andrew W. Chu: Reg. No. 46,625 Attorney for Applicant
Customer No. 24106	Egbert Law Offices 412 Main Street, 7th Floor Houston, Texas 77002 (713)224-8080 (713)223-4873 fax